

CALENDAR

Upcoming: June 7–10 Intl. Conf. on Advances in Solidification Processes (ASP), E-MRS; June 8–11 PLMCN, Endorsed; July 3–8 ICMAT 2005/IUMRS-ICAM, IUMRS/MRS-S; July 10–13 Organic Microelectronics Workshop, MRS; July 10–15 EP2DS-16, Endorsed.

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313; bulletin@mrs.org.

MRS, A-MRS, B-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the March 2005 MRS BULLETIN for May 2005 Calendar entries. For updates, access www.mrs.org/meetings/other/.

JUNE 2005

6–8 ▼ Information Photonics, Charlotte, NC. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, DC 20036, e-mail ip@osa.org; www.osa.org/ip.

7–10 Intl. Conf. on Advances in Solidification Processes (ASP), Stockholm, Sweden. KTH Casting of Metals, ASP, S-100 44, Stockholm, Sweden, 46-8-790-6654; fax 46-8-21-65-57; e-mail asp@matpr.kth.se; www.webforum.com/solidificationprocessing. **E-MRS.**

8–10 ▼ 7th Intl. Symp. on Sputtering and Plasma Processes, Kanazawa, Japan. E. Kusano, Kanazawa Inst. of Technology, Advanced Materials Science Ctr, 3-1 Yatsukaho Matto, Ishikawa, Japan, 81-76-274-9257; fax 81-76-274-9251; e-mail issp@www.kanazawa-it.ac.jp; issp2005.org.

8–11 PLMCN—Intl. Conf. on Physics of Light-Matter Coupling in Nanostructures, Glasgow, United Kingdom. e-mail plmcn5@phys.strath.ac.uk; plmcn5.phys.strath.ac.uk. **Endorsed.**

9–11 China Intl. Conf. on Nanoscience and Technology (ChinaNano2005), Beijing, Peoples Republic of China. e-mail chinanano@nanocn.cn; www.chinanano2005.org.

12–17 ECS—Intl. Conf. on Polymer Batteries and Fuel Cells (PBFC), Las Vegas, NV. The Electrochemical Society, 65 S. Main Street, Building D, Pennington, NJ, 08534-2839; 609-737-1092; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

13–15 Intl. Coatings, Paintings and Anti-Corrosion Expo, Beijing, China. Andrea Hillgardt, Mesago Holding Operations GmbH, Rotebuehlstr. 87, D-70178 Stuttgart, Germany, 49-711-490-890-23; fax 49-711-490-890-10; e-mail a.hillgardt@intercoat-china.com; www.china-intercoating.com.

14–17 ICOMAT—Intl. Conf. on Martensitic Transformation, Shanghai, China. e-mail icomat@sju.edu.cn; www.icomat.sju.edu.cn.

18–23 ▼ ESF—Biological Surfaces and Interfaces: Euroconference on Biomaterials, Biosensors, and Analytical Techniques, San Feliu De Guixols, Spain. Anne Guehl, ESF Research Conferences, 33-0-388-76-71-52; fax 33-0-388-36-69-87; www.esf.org/conferences/pc05187.

19–23 ▼ Intl. Conf. on Powder Metallurgy and Particulate Materials, Montreal, Canada. MPIF, 105 College Road East, Princeton, NJ, 08540; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpiif.org.

19–23 Intl. Congress on Thin Films and Intl. Conf. on Atomically Controlled Surfaces, Interfaces, and Nanostructures, Stockholm, Sweden. Congrex Sweden AB, P.O. Box 5619, SE-114 86, Stockholm, Sweden, 46-8-459-66-00; fax 46-8-661-91-25; e-mail acsin8@congrex.se; www.congrex.com/acsin8.

20–22 ISPAC: Intl. Symp. on Polymer Analysis and Characterization, Sheffield, United Kingdom. University of Sheffield, Shelagh Cowley, Dainton Building, Brook Hill, Sheffield, United Kingdom, 44-0-114-222-9537; fax 44-0-114-222-9389; e-mail s.h.cowley@sheffield.ac.uk; www.chem.cmu.edu/ispac.

20–22 ▼ TMS—Device Research Conf., Santa Barbara, CA. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/DRC.html.

21–24 ▼ SHS Intl. Symp. on Self-Propagating High-Temperature Synthesis, Cagliari, Italy. Raffaella Damerio, Via G. Colombo 81/A, Milano, Italy, 39-02-70608276; fax 39-02-59610042; e-mail SHS@aodic.it; www.aodic.it/SHS.

22–24 ▼ 2005 TMS Electronic Materials Conf., Santa Barbara, CA. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/EMC.html.

22–24 ▼ INFOS—Insulating Films on Semiconductors, Leuven, Belgium. infos2005, e-mail infos2005@momentum-pco.be; www.imec.be/infos.

26–30 17th University Conf. on Glass Science, University Park, PA. Donna Lucas, Materials Research Institute—Penn State University, 280 Materials Research Laboratory Building, University Park, PA 16802, 814-865-1656; fax 814-865-2326; e-mail dzm4@psu.edu; www.mri.psu.edu/conferences/glass-science/.

27–30 ▼ CNIC Intl. Scientific Congress, Havana, Cuba. CNIC, e-mail seminario@cnic.edu.cu; www.cnic.edu.cu/14Congreso/principal_eng.htm.

27–1 ▼ National Space and Missile Materials Symp. (NSMMS), Summerlin, NV. Dan Cleyrat, 937-656-6482; e-mail daniel.cleyrat@wpafb.af.mil; www.usasymposium.com/nsmms/default.htm.

JULY 2005

3–8 Intl. Conf. on Materials for Advanced Technologies (ICMAT 2005) and IUMRS-ICAM 2005, Singapore. Mat Research Soc (Singapore), ICMAT Secretariat, 3 Research Link, Singapore, 65-6874-1975; fax 65-6777-2393; e-mail icmat@mrs.org.sg; www.mrs.org.sg/meeting_future.html. **IUMRS/MRS-S/Endorsed.**

3–8 Intl. Conf. on Scanning Tunneling Microscopy/Spectroscopy and Related Techniques (STM) with the Intl. Colloquium on Scanning Probe Microscopy (ICSPM), Sapporo, Japan. Hokkaido University, Takaharu Okajima, Kita-ku N21 W10, Sapporo, Japan, 81-0-11-706-9341; fax 81-0-11-706-9355; e-mail stm05@es.hokudai.ac.jp; dora.ims.tsukuba.ac.jp/event/STM05/index.html.

4–8 Lucerne Fuel Cell Forum 2005, Lucerne, Switzerland. EFCE, Morgenacherstrasse 2F, P.O. Box 99, Oberrohrdorf, Switzerland, 41-56-496-7292; fax 41-56-496-441; e-mail forum@efce.com.

6–8 Intl. Conf. on Diffusion in Solids and Liquids (DSL-2005), Aveiro, Portugal. University of Aveiro, Dept. of Mechanical Engineering, Campus Universitario de Santiago, Aveiro, Portugal, 351-234-378162; fax 351-234-370953; e-mail DSL-2005@mec.ua.pt; event.ua.pt/dsl2005.

10–13 Organic Microelectronics Workshop, Newport, RI. 202-872-4600 or 800-227-5558; e-mail acsprospectives@acs.org; www.mrs.org/meetings/workshops/2005/organic_microelectronics. **MRS.**

10–14 ▼ Intl. Symp. on Optical Memory and Optical Data Storage, Honolulu, HI. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, DC 20036, e-mail ip@osa.org; www.osa.org/ods.

10–15 16th Intl. Conf. on Electronic Properties of Two-Dimensional Systems (EP2DS-16), Albuquerque, NM. Jerry Simmons, 505-844-8402; e-mail jsimmon@sandia.gov. **Endorsed.**

10–15 ▼ ACCGE—American Conf. on Crystal Growth and Epitaxy, Big Sky, MT. Laura Bonner, AACG, 25 4th Street, Somerville, NJ, 08876; 908-575-0803; fax 805-575-0794; e-mail aacg@att.net; www.crystal-growth.org/conferences/ACCGE16/index.php.

17–22 ▼ Gordon Research Conf. on Elastomers, New London, NH. Gregory McKenna, Texas Tech University, Lubbock, TX, 79409-3121; 806-742-3553; fax 806-742-3552; e-mail greg.mckenna@coe.ttu.edu; www.grc.uri.edu/05sched.htm.

17–22 Intl. Conf. on Solid State Ionics (SSI-15), Baden-Baden, Germany. Ellen Ivers-Tiffée, c/o Universität Karlsruhe, Kaiserstr. 12, D-76131 Karlsruhe, Germany; 49-721-608-7491; fax 49-721-608-7492; e-mail info@ssi-15.net; www.ssi-15.net.

19–23 5th Intl. Conf. on Intelligent Processing and Manufacturing of Materials, Monterey, CA. IPMM 05, www.mining.ubc.ca/ipmm.

20–22 ▼ Intl. Conf. on Bio-Nano-Informatics (BNI) Fusion, Marina del Rey, CA. Institute for Cell Mimetic Space Exploration, 7702 Boelter Hall, Los Angeles, CA, 90095-1600; e-mail bnifusion@seas.ucla.edu; www.bnifusion.org/home.html.

30–3 ▼ Symp. of the Protein Society, Boston, MA. The Protein Society, e-mail jlash@faseb.org; www.faseb.org/meetings/exhibit.

31–4 ▼ Microscopy and Microanalysis, Honolulu, HI. Meeting Management Microscopy and Microanalysis, 877-MSA-MAS-1; fax 708-361-6166; e-mail msa@tradeshownet.com; mm2005.microscopy.org.

31–4 ▼ SPIE—Optics Photonics: NanoPhotonics, San Diego, CA. SPIE Meetings, P.O. Box 10, Bellingham, WA, 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org/Conferences/calls/05/am.

AUGUST 2005

1–3 ▼ Intl. Surface Engineering Congress and Exposition, St. Paul, MN. ASM Customer Service, 9639 Kinsman Road, Kinsman Park, OH, 44073-0002; 800-336-5152; fax 440-338-4634; e-mail Cust-srv@asminternational.org; www.asminternational.org/surface.

13–16 ▼ Particles: Surface Modification in Particle Technology, San Francisco, CA. Particles Conf., 585-288-5913; fax 585-482-7795; e-mail info@nanoparticles.org; www.nanoparticles.org/Particles2005.

14–19 ▼ Gordon Research Conf.: Combinatorial & High Throughput Materials Science III, Oxford, UK. www.grc.org/programs/2005/comhigh.htm. **Endorsed.**

16–19 ▼ Canadian Semiconductor Technology Conf., Ottawa, Canada. National Research Council of Canada, Michelle Robitaille Canadian Semiconductor Conf., 1200 Montreal Road, Building M-19, Ottawa, ON, K1A 0R6; 613-993-9495; fax 613-993-7250; e-mail semi2005@nrc-cnrc.gc.ca; www.canadiansemiconductor.org.

21–24 ▼ COM—Conf. of Metallurgists, Toronto, Canada. Kumar Sadayappan, CANMET/MTL, 568 Booth St., Ottawa, ON, K1A 0G1; 613-992-0741; fax 613-992-8735; e-mail ksadayap@nrcan.gc.ca; www.metsoc.org/conferences/com2005/default.asp.

21–25 IMRC—Intl. Materials Research Congress, Cancun, Mexico. Ventura Rodriguez Lugo, 29 Oriente 601-1, Col Ladrillera De Benitez, Puebla, Mexico, 52-222-211-4393; fax 52-222-211-4393; e-mail lugo.ventura@cuv.buap.mx; www.viep.buap.mx/imrc2005.htm. **M-MRS.**

25-26 ▼ RP Asia—Reinforced Plastics, *Bangkok, Thailand*. Mark Sherman, Elsevier Advanced Technology, The Boulevard, Langford Lane, Kidlington, Oxford, United Kingdom, 44-0-1865-843208; fax 44-0-1865-843973; e-mail m.sherman@elsevier.com; www.rpsasia.com/showdoc.asp?docid=42670840.

28-2 6th Intl. Conf. on Nitride Semiconductors (ICNS-6), *Bremen, Germany*. Sven Einfeldt, University of Bremen, P.O. Box 330440, Bremen, Germany; 49-421-218-7453; fax 49-421-218-4581; e-mail icns6@ifp.uni-bremen.de; www.ifp.uni-bremen.de/icns6.

29-2 ▼ CEC/ICMC—Cryogenic Engineering Conf. and Intl. Cryogenic Materials Conf., *Keystone, CO*. Centennial Conferences, 901 Front Street, Suite 130, Louisville, CO, 80027; 303-499-2299; fax 303-499-2599; e-mail cecicmc05@centennialconferences.com; www.cec-icmc.org.

30-2 ECSSC X 2005 European Conf. on Solid State Chemistry, *Sheffield, United Kingdom*. Louise Draycott, University of Sheffield, Sir Robert Hadfield Building, Mappin Street, Sheffield, United Kingdom, 44-0-114-222-60-27; fax 44-0-114-222-59-43; e-mail L.Draycott@sheffield.ac.uk; www.shef.ac.uk/materials/ecssc.

SEPTEMBER 2005

4-9 SMMIB—Intl. Conf. on Surface Modification of Materials by Ion Beams, *Kusadasi, Turkey*. Conference Secretary SMMIB, 90-232-343-44-00; fax 90-232-374-42-89; e-mail info@smmib05.net; www.smmib05.net. **Endorsed**.

5-8 ▼ EUROMAT 2005—European Congress on Advanced Materials and Processes, *Prague, Czech Republic*. Deutsche Gesells für Materialk., Euromat 2005 Congress Office, Hamburger Allee 26, Frankfurt, Germany, 49-69-7917-747; fax 49-69-7917-733; e-mail euromat@fems.org; www.euromat2005.fems.org.

7-9 ICSCNanoSMat—Intl. Conf. on Surfaces Coatings and Nanostructured Materials, *Aveiro, Portugal*. Sabrina Morais, University of Aveiro, 3810-193 Aveiro, Portugal, 351-234-378-177; fax 351-234-370-953; e-mail ICSCNM@mec.ua.pt; www.mec.ua.pt/ICSCNM.

12-14 ▼ Intl. Workshop on Stress-Induced Phenomena in Metallization, *Dresden, Germany*. AMD Saxony LLC and Co. KG, Ehrenfried Zschech, P. O. Box 11 01 10, Dresden, Germany, 49-0-351-2-77-4100; fax 49-0-351-2-7794100; e-mail ehrenfried.zschech@amd.com; www.malab.com/stress_workshop_2005.

12-16 ECI—Micromechanics and Microstructure Evolution: Modeling, Simulation and Experiments, *Madrid, Spain*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/5as.html.

12-16 European Solid-State Device Research Conf. (ESSDERC), *Grenoble, France*. Iris Mazure, 46 Avenue Felix Viallet, Grenoble Cedex, France, 33-476-57-49-89; fax 33-476-47-38-14; e-mail esscirc-essderc@imag.fr; www.essderc2005.com.

12-16 ▼ Scientific Basis for Nuclear Waste Management, *Ghent, Belgium*. SCKCEN, e-mail MRS2005@sckcen.be; www.sckcen.be/sckcen_en/activities/conf/conferences/MRS2005/index.shtml. **Endorsed**.

12-16 ▼ YUCOMAT—Yugoslav Materials Research Society Conf., *Herceg Novi, Yugoslavia*. Aleksandra Stojicic, Knez Mihailova 35/IV, P.O. Box 315, 11000 Belgrade, Serbia and Montenegro, Yugoslavia, e-mail yumrs@itn.sanu.ac.yu; www.yu-mrs.org.yu/prod02.htm. **E-MRS**.

18-22 ▼ ISCS—Intl. Symp. on Compound Semiconductors, *Rust, Germany*. ISCS, Fraunhofer IAF, Tullastr. 72, Freiburg, Germany, 49-0-7-61-51-59800; fax 49-0-7-61-51-59677; e-mail iscs2005@iaf.fraunhofer.de; www.iscs2005.com.

18-23 ▼ ECI—Nanostructured Materials: Environmental, Energy, and Sensing Applications, *Barga, Italy*. Engineering Conferences International, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/5az.html.

18-23 ▼ TMS—ICSCRM: Intl. Conf. on Silicon Carbide and Related Materials, *Santa Barbara, CA*. TMS, TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/Meetings/Specialty/ICSCRM2005/home.html.

27-29 ▼ Advanced Metallization Conf., *Colorado Springs, CO*. Jenny Black Deer, Program Rep., Business and Technology, UC Berkeley Extension, 1995 University Ave, #7010, Berkeley, CA 94720-7010; 510-642-4151; fax 510-642-6027; e-mail jlb@unex.berkeley.edu; www.unex.berkeley.edu/eng/metal. **Endorsed**.

27-30 ▼ 11th Intl. Conf. on Thermal Investigations of IC's and Systems, *Lake Maggiore, Italy*. http://tima.imag.fr/conferences/therminic. **Endorsed**.

OCTOBER 2005

2-5 3rd Fracture and Flow in Advanced Glasses Conf., *University Park, PA*. Carlo Pantano; ars2@psu.edu.

2-5 ▼ Powder Metallurgy Congress and Exhibition (PM2005), *Prague, Czech Republic*. Powder Metallurgy, Old Bank Buildings, Bellstone, Shrewsbury, United Kingdom, 44-0-1743-248899; fax 44-0-1743-362968; e-mail info@epma.com; www.epma.com/pm2005.

3-5 ▼ Three-Dimensional Multifunctional Ceramic Composites Workshop, *Urbana, IL*. Materials Research Society, 506 Keystone Drive, Pittsburgh, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org/meetings/workshop. **MRS**.

4-6 ▼ 2nd Intl. Symp. on Point Defect and Nonstoichiometry ISPN-2, *Kaohsiung, Taiwan*. National Sun Yat-Sen University, Mitch Chou, Kaohsiung 804, Taiwan, 886-7-5252000 ext; fax 886-7-5254099; e-mail mitch@mail.nsysu.edu.tw; www.mse.nsysu.edu.tw/ispn2005.

4-6 ▼ Grove Fuel Cell Symp., *London, United Kingdom*. Gill Heaton, Elsevier, Hillside Cottages, Wheatley Rd., Islip, Oxford, United Kingdom, 44-1865-373625; fax 44-1865-375855; e-mail wom-conference@elsevier.com; www.grovetfuelcell.com.

6-7 IACC—Intl. Activated Carbon Conf., *Pittsburgh, PA*. Henry Nowicki, PACS Testing and Consulting, 409 Meade Drive, Coraopolis, PA, 15108; 724-457-6576; fax 724-457-1214; e-mail hnpacs@aol.com; www.pacslabs.com.

9-14 ECI—Instrumented Indentation Testing in Materials Research and Development, *Crete, Greece*. E-mail info@eci.poly.edu; www.engconfintl.org/5av.html.

12-16 AIOM—Advances in Optical Materials, *Tucson, AZ*. Sophie Peters AIOM Conference Secretariat, Elsevier, The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, United Kingdom, 44-0-1865-843643; fax 44-0-1865-843958; e-mail s.peters@elsevier.com; www.aiom.elsevier.com.

16-21 ECS—Electrochemical Society Meeting, *Los Angeles, CA*. The Electrochemical Society, 65 S. Main Street, Building D, Pennington, NJ, 08534-2839; 609-737-1092; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

17-19 ▼ Light Emitting Diodes 2005, *San Diego, CA*. Intertech USA, INTERTECH, 19 Northbrook Drive, Portland, ME, 04105; 207-781-9800; fax 207-781-2150; e-mail info@Intertechusa.com; www.intertechusa.com/leds.html.

17-20 ▼ IEEE Integrated Reliability Workshop 2005, *Fallen Leaf Lake, CA*. www.iirw.org.

17-21 ASNT Fall Conf. and Quality Testing Show 2005, *Columbus, OH*. Kelly Thomas, American Society for Nondestructive Testing, P.O. Box 28518, 1711 Arlington Ln, Columbus, OH 43228-0518; 800-222-2768 x227; fax 614-274-6899; kthomas@asnt.org; www.asnt.org.

17-21 ▼ Intl. Astronautical Congress (IAC) 2005, *Fukuoka, Japan*. Secretariat Intl. Astronautical Congress 2005, 1-18-2 Shinbashi Minato-ku, Tokyo, Japan, 81-3-3503-8151; fax 81-3-3503-8152; e-mail info@iac2005.org; www.iac2005.org.

30-3 ▼ SAMPE—Intl. Fall Technical Conf. (ISTC), *Seattle, WA*. SAMPE, e-mail registration@sampe.org; www.sampe.org.

31-3 ▼ ICALEO—Intl. Congress on Applications of Lasers and Electro-Optics, *Miami, FL*. Laser Institute of America, 13501 Ingenuity Drive, Suite 128, Orlando, FL, 32826; 407-380-1553; fax 407-380-5588; e-mail conferences@laserinstitute.org; www.icalao.org.

NOVEMBER 2005

13-17 ▼ SETAC North America Annual Meeting, *Baltimore, MD*. SETAC North America, 1010 North 12th Avenue, Pensacola, FL, 32501-3370; 850-469-1500; fax 580-469-9778; e-mail setac@setac.org; www.setac.org.

14-16 Continuous Casting of Non-Ferrous Metals Intl. Conf. & Exhibition, *Neu-Ulm, Germany*. Vera Hausen, Niels Parusel, DGM Secretariat, Deutsche Gesellschaft für Materialkunde, Hamburger Allee 26, Frankfurt, Germany, 49-69-7917-747; fax 49-69-7917-733; e-mail concast@dgm.de; www.dgm.de/concast.

22-25 Ninth NCB Intl. Seminar on Cement, *New Delhi, India*. NCCBM, Ninth NCB, 34 Km Stone, Delhi Mathura Road (NH2), Ballabgarh 121 004, Haryana, India, 91-129-2242051-56; fax 91-129-2242100, 2246175; e-mail nccbm@giasd101.vsnl.net.in.

29-3 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**.

DECEMBER 2005

2-3 ▼ European Coatings Conf.: The Power of Ink Jet Materials, *Berlin, Germany*. Vincenz Network, Amanda Beyer, Schiffgraben 43, 30175 Hannover, Germany, 49-511-99-10-271; fax 49-511-99-10-279; e-mail amanda.beyer@coatings.de; www.coatings.de.

4-9 Intl. Conf. on Fusion Reactor Materials, *Santa Barbara, CA*. R. J. Kurtz, e-mail icfrm-tp@engineering.ucsb.edu; icfrm-12.pnl.gov/index.stm.

5-7 2nd Intl. Conf. on Advances in Production and Processing of Aluminum (APPA 2005), *Bahrain*. Conf. Secretariat (APPA 2005), Univ. of Bahrain, P.O. Box 32038, Bahrain, 973-17876114; fax 973-17876655; e-mail appa2005@eng.uob.bh; www.uob.edu.bh/colleges/engineering/conf/index.htm.

24-26 ▼ Intl. Congress of Chemistry and Environment, *Indore, India*. Intl. Congress of Chemistry and Environment, ICCE, A/80, Scheme No. 54, Vijay Nagar, A.B. Road, Indore, India, 91-731-2552837; fax 91-731-2552837; e-mail iccechem@sancharnet.in; www.chemenviron.com/c/chemenviron_cong.htm.

MARCH 2006

12-16 ▼ 2006 TMS Annual Meeting and Exhibition, *San Antonio, TX*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/meetings/meetings.asp.

13-17 ▼ 2006 APS March Meeting, *Baltimore, MD*. American Physics Society, e-mail meetings@aps.org; www.aps.org/meet.

17-18 ▼ SPE—European Thermofforming Conf., *Salzburg, Austria*. SPE—Europe, Belgium, 32-0-3-541-77-55; fax 32-0-3-541-84-25; e-mail spe.europe@pi.be; www.4spe.org/conf/0603euthermp.php.

APRIL 2006

17-21 ▼ 2006 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**.

22-26 ▼ ICMOVPE—Intl. Conf. on Metal-Organic Vapor Phase Epitaxy, *Miyazaki, Japan*. Tokyo University of A and T, Yoshinao Kumagai, Koganei, Tokyo 184-8588, Japan, 81-42-388-7469; fax 81-42-386-3003; e-mail icmovpe@cctuat.ac.jp; www.icmovpe-2002.de.

22-27 ▼ 49th SVC Annual Technical Conf., *Washington, D.C.* Society of Vacuum Coaters, 505-856-7188; e-mail svcinfo@svc.org; www.svc.org.

27-30 ▼ SFB 2006—Society for Biomaterials Annual Meeting and Exposition, *Pittsburgh, PA*. Rebecca Hanes Society for Biomaterials, 17000 Commerce Parkway, Suite, Mt. Laurel, 856-439-0826 x3061; fax 856-439-0525; e-mail rhaines@ahint.com; www.biomaterials.org/Meetings/meetings.htm.

28-2 ▼ MCWASP—Modeling of Casting, Welding and Advanced Solidification Processes Conf., *Opio, France*. ESA Conference Bureau/Congrex Holland BV, P.O. Box 299, AG Noordwijk, Netherlands, 31-71-565-5005; fax 31-71-565-5658; e-mail Esa.Conference.Bureau@esa.int; www.mcwasp.org.

JUNE 2006

6-8 ▼ **Magneto-Optical Recording Intl. Symp. 2006 (MORIS 2006) Workshop**, *Chiba Prefecture, Japan*. MORIS 2006 Workshop Secretariat, Proactive Inc., Promena Kobe 16F, 1-8-1, Higashikawasaki-cho, Chuo-ku, Kobe 650-0044, Japan; 81-78-366-5050; fax 81-78-366-5051; moris2006ws@pac.ne.jp; www.ecs.cst.nihon-u.ac.jp/moris2006ws. **Endorsed**.

JULY 2006

2-7 ▼ 21st International Liquid Crystal Conference, *Keystone, CO*. Conference Management Office, Kinsley & Associates, LLC, 303.798.3664; ilcc@kinsleyassociates.com; www.ilcc2006.com.

AUGUST 2006

27-31 TMS—Sohn Intl. Symp. on Advanced Materials: Principles, Technologies, and Industrial Practice, *San Diego, CA*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/Meetings/Specialty/FallExt2006/FallExt2006-Home.html. **Endorsed**.

SEPTEMBER 2006

10-15 ▼ ESOMAT—European Symp. on Martensitic Transformations, *Bochum, Germany*. ESOMAT, e-mail esomat06@ruhr-uni-bochum.de; www.ruhr-uni-bochum.de/esomat06.

NOVEMBER 2006

27-2 ▼ 2006 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**.

FEBRUARY 2007

25-1 ▼ 2007 TMS Annual Meeting and Exhibition, *Orlando, FL*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/meetings/meetings.asp.

APRIL 2007

9-13 ▼ 2007 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**. □